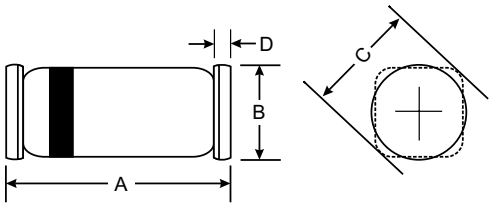
LS4154

SURFACE MOUNT FAST SWITCHING DIODE

Features

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose Switching Applications
- High Conductance
- Outline Similar to JEDEC 213AA



Mechanical Data

- Case: QuadroMELF, Glass
- Terminals: Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Marking: Cathode Band Only
- Weight: 0.034 grams (approx.)

QuadroMELF		
Dim	**Min**	**Max**
A	3.3	3.7
B	1.4	1.6
C	1.7∅ Typical	
D	0.3 Typical	
All Dimensions in mm		

Maximum Ratings @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	LS4154	Unit
Non-Repetitive Peak Reverse Voltage	V_{RM}	35	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	25	V
RMS Reverse Voltage	$V_{R(RMS)}$	17	V
Forward Continuous Current (Note 1)	I_{FM}	300	mA
Average Rectified Output Current (Note 1)	I_O	150	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs	I_{FSM}	2.0	A
Power Dissipation	P_d	500	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{\theta JA}$	300	K/W
Operating and Storage Temperature Range	T_j , T_{STG}	-65 to +175	°C

Electrical Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Maximum Forward Voltage	V_{FM}	—	1.0	V	I_F = 30mA
Maximum Peak Reverse Current	I_{RM}	— —	100 100	nA μA	V_R = 25V V_R = 25V, T_j = 150°C
Junction Capacitance	C_j	—	4.0	pF	V_R = 0, f = 1.0MHz
Reverse Recovery Time	t_{rr}	—	2.0	ns	I_F = I_R = 10mA, I_{rr} = 0.1 x I_R, R_L = 100Ω

Notes: 1. Valid provided that electrodes are kept at ambient temperature.

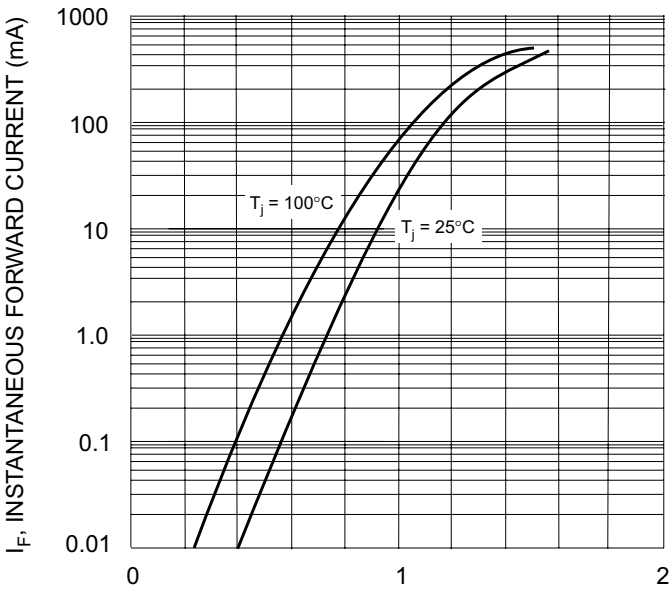


Fig. 1 Forward Characteristics

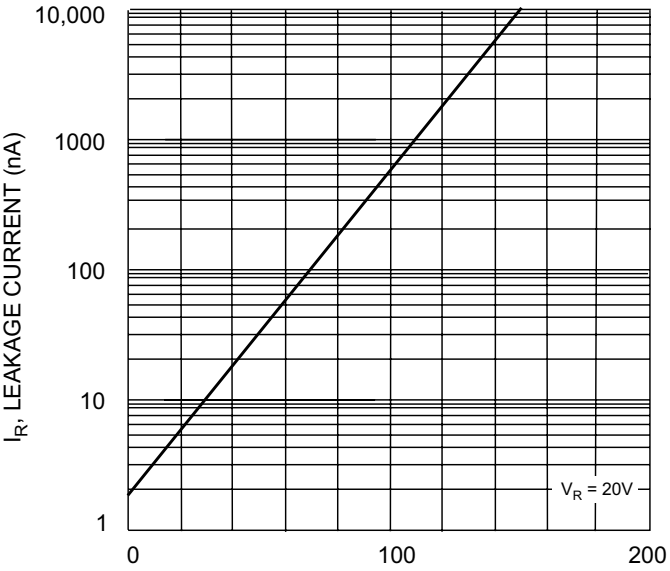


Fig. 2 Leakage Current vs Junction Temperature